

M-15281US
10/753,673**IN THE CLAIMS**

The following is a complete listing of the pending claims:

1. (currently amended) A two-transistor PMOS memory cell, comprising:
a PMOS select transistor having a drain and a source formed as separate P+ diffusion regions in an N- well;
a PMOS floating gate transistor having a drain and a source formed as separate P+ diffusion regions in the N-well, wherein the P+ diffusion region that forms the floating gate transistor's drain is the same P+ diffusion region that forms the select gate transistor's source;
and
an N implant underlying only the P+ diffusion region that forms the floating gate transistor's drain such that an N implant does not underlie either of the P+ diffusion regions forming the select gate's transistor drain and the floating gate's transistor's source.
2. (original) The two-transistor PMOS memory cell of claim 1, wherein the lateral extent of the N implant is substantially the same as the lateral extent of the P+ diffusion region that forms the PMOS floating gate transistor's drain.
3. (original) The two-transistor PMOS memory cell of claim 2, wherein the drain of the PMOS select transistor couples to a bit line of a memory array, and wherein a select gate of the PMOS select transistor couples to a word line of the memory array.
4. (original) The two-transistor PMOS memory cell of claim 2, wherein a floating gate of the PMOS floating gate transistor is formed in a first polysilicon layer, and wherein a

LAW OFFICES OF
MACPHERSON KWOK
CHEN & HEID LLP2402 Michelson Drive
SUITE 210
Irvine, CA 92612
(949) 753-7040
FAX (949) 753-7049

M-15281US
10/753,673

control gate of the PMOS floating gate transistor is formed in a second polysilicon layer.

5. (original) The two-transistor PMOS memory cell of claim 2, wherein the memory cell includes a single polysilicon layer containing a floating gate of the PMOS floating gate transistor, and wherein a control gate of the PMOS floating gate transistor is formed as a P+ diffusion region in the N- well.

6. (original) The two-transistor PMOS memory cell of claim 2, wherein the memory cell is configured such that the floating gate transistor may be programmed using band-to-band tunneling.

7. (original) The two-transistor PMOS memory cell of claim 2, wherein the memory cell is configured such that the floating gate transistor may be programmed using Fowler Nordheim tunneling.

8. (original) The two-transistor PMOS memory cell of claim 2, wherein the P+ diffusion region that forms the floating gate transistor's drain has a thickness of approximately 0.1 to 0.25 microns.

9. (original) The two-transistor PMOS memory cell of claim 2, wherein the thickness of the N implant underlying the P+ diffusion region that forms the floating gate transistor's drain is approximately 0.1 to 0.25 microns.

10. (withdrawn)

LAW OFFICES OF
MACPHERSON KWOK
CHEN & HUNG LLP
2402 Michelson Drive
SUITE 210
Irvine, CA 92613
(949) 753-7039
FAX (949) 752-7049

M-15281US
10/753,673

11. (withdrawn)

12. (withdrawn)

13. (withdrawn)

14. (withdrawn)

LAW OFFICES OF
MACPHERSON KWOK
CHEN & HEID LLP

2402 Michelson Drive
SUITE 210
Irvine, CA 92612
(949) 753-7040
FAX (949) 752-7049